

torney Docket No.: 42P12897

**PATENT** 

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:	)
Dias et al.	Examiner: Hoai V. Pham
Application No: 10/000,229	Art Unit: 2814
Filed: November 30, 2001	)  I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail with sufficient postage
For: Backside Metallization on Sides of Microelectronic Dice for Effective Thermal Contact with	in an envelope addressed to the Commissioner of Patents, Washington, D.C. 20231 on: ) 14 JANUARY 2003
HEAT DISSIPATION DEVICES	DEBORAH L. HICHON
Box Non-Fee Amendment Assistant Commissioner For Patents Washington, D.C. 20231	Name of Person Mailing Correspondence Signature  Date

## <u>AMENDMENT</u>

Dear Sir:

In response to the Office Action mailed December 17, 2002, Applicants elect Claim Set I, as set forth in the December 17, 2002 Office Action, which includes claims 1-14 without traverse. Please charge any shortages and credit any overcharges to our Deposit Account number 02-2666.

> Respectfully submitted, BLAKELY, SOKOLOFF, TAYLOR & ZAFMAN, LLP

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